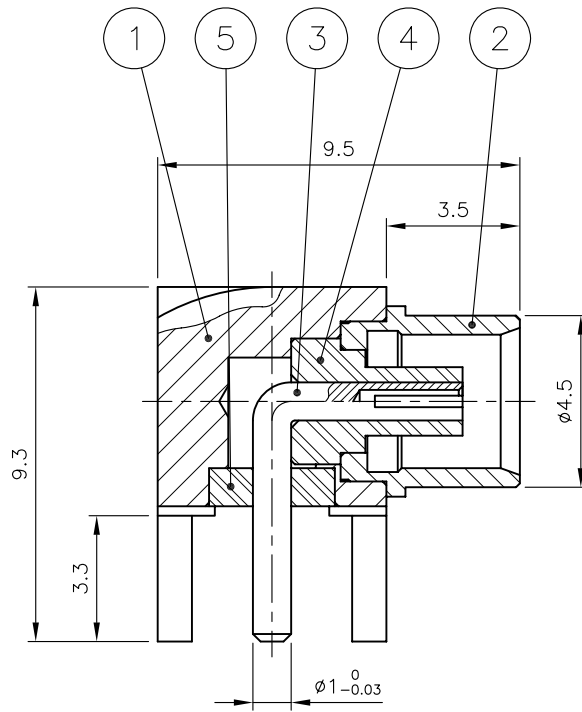
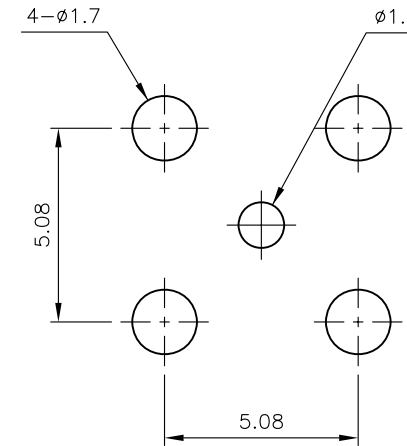
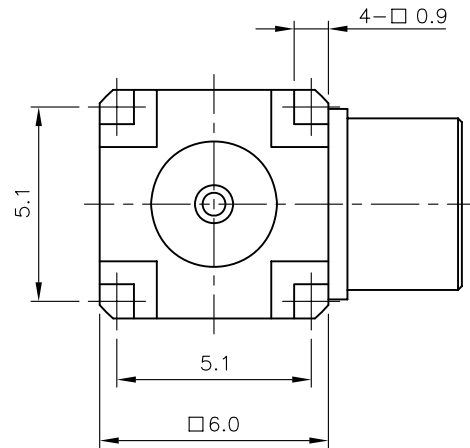




REVISION		
REV	DESCRIPTION	DATE
IR	Initial Registration	2006.03.07.
A	[설번처리No.200911-0004] 사각BODY 현실화에 따른 연취 추가	2009.11.11.
B	[설번처리No.201001-0011] 가공 및 조립성 개선	2010.01.22.



PCB MOUNTING HOLE



5	INSULATOR	1	TEFLON		DIN00018-N/2
4	INSULATOR	1	TEFLON		DIN00026-N/3
3	CONTACT	1	BeCu	Gold Plate	DCT00058-5/1
2	BODY	1	MBsBD	Gold Plate	DBD00067-5/2
1	사각 BODY	1	MBsBD	Gold Plate	DBD00057-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2010. 01. 22.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	Y.H.CHOI	
MATERIAL		CHECKED BY		TITLE MCX50 PCB JL-4R
		DRAWN BY		
FINISH		SCALE	5/1	DWG NO. CN01330-7/2
		UNIT	mm	REVISION B SHEET 1 of 1